

DS90C031 LVDS Quad CMOS Differential Line Driver

General Description

The DS90C031 is a quad CMOS differential line driver designed for applications requiring ultra low power dissipation and high data rates. The device is designed to support data rates in excess of 155.5 Mbps (77.7 MHz) utilizing Low Voltage Differential Signaling (LVDS) technology.

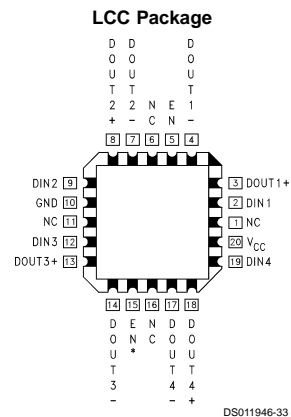
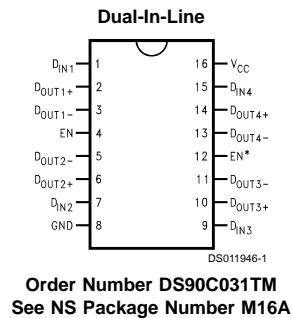
The DS90C031 accepts TTL/CMOS input levels and translates them to low voltage (350 mV) differential output signals. In addition the driver supports a TRI-STATE[®] function that may be used to disable the output stage, disabling the load current, and thus dropping the device to an ultra low idle power state of 11 mW typical.

The DS90C031 and companion line receiver (DS90C032) provide a new alternative to high power psuedo-ECL devices for high speed point-to-point interface applications.

Features

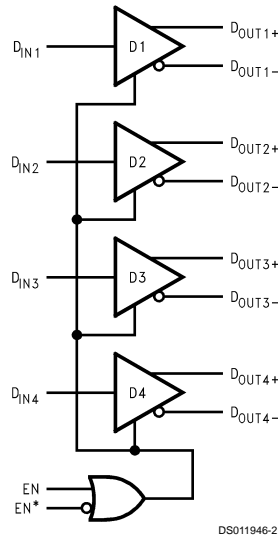
- >155.5 Mbps (77.7 MHz) switching rates
- ±350 mV differential signaling
- Ultra low power dissipation
- 400 ps maximum differential skew (5V, 25°C)
- 3.5 ns maximum propagation delay
- Industrial operating temperature range
- Military operating temperature range option
- Available in surface mount packaging (SOIC) and (LCC)
- Pin compatible with DS26C31, MB571 (PECL) and 41LG (PECL)
- Compatible with IEEE 1596.3 SCI LVDS standard
- Conforms to ANSI/TIA/EIA-644 LVDS standard
- Available to Standard Microcircuit Drawing (SMD) 5962-95833

Connection Diagrams



TRI-STATE[®] is a registered trademark of National Semiconductor Corporation.

Functional Diagram



Truth Table

DRIVER

| Enables | | Input D_{IN} | Outputs | |
|--|-----|-------------------|------------|------------|
| EN | EN* | | D_{OUT+} | D_{OUT-} |
| L | H | X | Z | Z |
| All other combinations of ENABLE inputs | | L | L | H |
| | | H | H | L |

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

| | |
|--|------------------------------|
| Supply Voltage (V_{CC}) | -0.3V to +6V |
| Input Voltage (D_{IN}) | -0.3V to ($V_{CC} + 0.3V$) |
| Enable Input Voltage (EN, EN*) | -0.3V to ($V_{CC} + 0.3V$) |
| Output Voltage (D_{OUT+} , D_{OUT-}) | -0.3V to ($V_{CC} + 0.3V$) |
| Short Circuit Duration (D_{OUT+} , D_{OUT-}) | Continuous |
| Maximum Package Power Dissipation @ +25°C | |
| M Package | 1068 mW |
| E Package | 1900 mW |
| Derate M Package | 8.5 mW/°C above +25°C |
| Derate E Package | 12.8 mW/°C above +25°C |
| Storage Temperature Range | -65°C to +150°C |
| Lead Temperature Range | |
| Soldering (4 sec.) | +260°C |

| | |
|--|----------|
| Maximum Junction Temperature (DS90C031T) | +150°C |
| Maximum Junction Temperature (DS90C031E) | +175°C |
| ESD Rating (Note 7) | |
| (HBM, 1.5 kΩ, 100 pF) | ≥ 3,500V |
| (EIAJ, 0 Ω, 200 pF) | ≥ 250V |

Recommended Operating Conditions

| | Min | Typ | Max | Units |
|--|------|------|------|-------|
| Supply Voltage (V_{CC}) | +4.5 | +5.0 | +5.5 | V |
| Operating Free Air Temperature (T_A) | | | | |
| DS90C031T | -40 | +25 | +85 | °C |
| DS90C031E | -55 | +25 | +125 | °C |

Electrical Characteristics

Over supply voltage and operating temperature ranges, unless otherwise specified. (Notes 2, 3)

| Symbol | Parameter | Conditions | Pin | Min | Typ | Max | Units | |
|------------------|--|--|--------------------|----------|------|----------|-------|----|
| V_{OD1} | Differential Output Voltage | $R_L = 100\Omega$ (Figure 1) | D_{OUT-} | 250 | 345 | 450 | mV | |
| ΔV_{OD1} | Change in Magnitude of V_{OD1} for Complementary Output States | | D_{OUT+} | | 4 | 35 | mV | |
| V_{OS} | Offset Voltage | | | 1.125 | 1.25 | 1.375 | V | |
| ΔV_{OS} | Change in Magnitude of V_{OS} for Complementary Output States | | | | 5 | 25 | mV | |
| V_{OH} | Output Voltage High | $R_L = 100\Omega$ | | | 1.41 | 1.60 | V | |
| V_{OL} | Output Voltage Low | | | 0.90 | 1.07 | | V | |
| V_{IH} | Input Voltage High | | D_{IN} , EN, EN* | 2.0 | | V_{CC} | V | |
| V_{IL} | Input Voltage Low | | | GND | | 0.8 | V | |
| I_I | Input Current | $V_{IN} = V_{CC}$, GND, 2.5V or 0.4V | | -10 | ±1 | +10 | μA | |
| V_{CL} | Input Clamp Voltage | $I_{CL} = -18$ mA | | -1.5 | -0.8 | | V | |
| I_{OS} | Output Short Circuit Current | $V_{OUT} = 0V$ (Note 8) | D_{OUT-} | | -3.5 | -5.0 | mA | |
| I_{OZ} | Output TRI-STATE Current | EN = 0.8V and EN* = 2.0V, $V_{OUT} = 0V$ or V_{CC} | D_{OUT+} | -10 | ±1 | +10 | μA | |
| I_{CC} | No Load Supply Current Drivers Enabled | $D_{IN} = V_{CC}$ or GND | DS90C031T | V_{CC} | | 1.7 | 3.0 | mA |
| | | $D_{IN} = 2.5V$ or 0.4V | | | | 4.0 | 6.5 | mA |
| I_{CCL} | Loaded Supply Current Drivers Enabled | $R_L = 100\Omega$ All Channels | DS90C031T | | | 15.4 | 21.0 | mA |
| | | $V_{IN} = V_{CC}$ or GND (all inputs) | DS90C031E | | | 15.4 | 25.0 | mA |
| I_{CCZ} | No Load Supply Current Drivers Disabled | $D_{IN} = V_{CC}$ or GND | DS90C031T | | | 2.2 | 4.0 | mA |
| | | EN = GND, EN* = V_{CC} | DS90C031E | | | 2.2 | 10.0 | mA |

Switching Characteristics

$V_{CC} = +5.0V$, $T_A = +25^\circ C$ DS90C031T. (Notes 3, 4, 6, 9)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|------------|--|--|-----|-----|-----|-------|
| t_{PHLD} | Differential Propagation Delay High to Low | $R_L = 100\Omega$, $C_L = 5$ pF (Figure 2 and Figure 3) | 1.0 | 2.0 | 3.0 | ns |
| t_{PLHD} | Differential Propagation Delay Low to High | | 1.0 | 2.1 | 3.0 | ns |
| t_{SKD} | Differential Skew $ t_{PHLD} - t_{PLHD} $ | | 0 | 80 | 400 | ps |
| t_{SK1} | Channel-to-Channel Skew (Note 4) | | 0 | 300 | 600 | ps |

Switching Characteristics (Continued)

$V_{CC} = +5.0V$, $T_A = +25^\circ C$ DS90C031T. (Notes 3, 4, 6, 9)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|-----------|------------------------|---|-----|------|-----|-------|
| t_{TLH} | Rise Time | $R_L = 100\Omega$, $C_L = 5\text{ pF}$ (Figure 4 and Figure 5) | | 0.35 | 1.5 | ns |
| t_{THL} | Fall Time | | | 0.35 | 1.5 | ns |
| t_{PHZ} | Disable Time High to Z | | | 2.5 | 10 | ns |
| t_{PLZ} | Disable Time Low to Z | | | 2.5 | 10 | ns |
| t_{PZH} | Enable Time Z to High | | | 2.5 | 10 | ns |
| t_{PZL} | Enable Time Z to Low | | | 2.5 | 10 | ns |

Switching Characteristics

$V_{CC} = +5.0V \pm 10\%$, $T_A = -40^\circ C$ to $+85^\circ C$ DS90C031T. (Notes 3, 4, 5, 6, 9)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|------------|--|---|-----|------|------|-------|
| t_{PHLD} | Differential Propagation Delay High to Low | $R_L = 100\Omega$, $C_L = 5\text{ pF}$ (Figure 2 and Figure 3) | 0.5 | 2.0 | 3.5 | ns |
| t_{PLHD} | Differential Propagation Delay Low to High | | 0.5 | 2.1 | 3.5 | ns |
| t_{SKD} | Differential Skew $ t_{PHLD} - t_{PLHD} $ | | 0 | 80 | 900 | ps |
| t_{SK1} | Channel-to-Channel Skew (Note 4) | | 0 | 0.3 | 1.0 | ns |
| t_{SK2} | Chip to Chip Skew (Note 5) | | | | 3.0 | ns |
| t_{TLH} | Rise Time | | | | 0.35 | 2.0 |
| t_{THL} | Fall Time | | | 0.35 | 2.0 | ns |
| t_{PHZ} | Disable Time High to Z | $R_L = 100\Omega$, $C_L = 5\text{ pF}$ (Figure 4 and Figure 5) | | 2.5 | 15 | ns |
| t_{PLZ} | Disable Time Low to Z | | | 2.5 | 15 | ns |
| t_{PZH} | Enable Time Z to High | | | 2.5 | 15 | ns |
| t_{PZL} | Enable Time Z to Low | | | 2.5 | 15 | ns |

Switching Characteristics

$V_{CC} = +5.0V \pm 10\%$, $T_A = -55^\circ C$ to $+125^\circ C$ DS90C031E. (Notes 3, 4, 5, 6, 9, 10)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|------------|--|---|-----|------|-----|-------|
| t_{PHLD} | Differential Propagation Delay High to Low | $R_L = 100\Omega$, $C_L = 20\text{ pF}$ (Figure 3) | 0.5 | 2.0 | 5.0 | ns |
| t_{PLHD} | Differential Propagation Delay Low to High | | 0.5 | 2.1 | 5.0 | ns |
| t_{SKD} | Differential Skew $ t_{PHLD} - t_{PLHD} $ | C_L Connected between each Output and GND | 0 | 0.08 | 3.0 | ns |
| t_{SK1} | Channel-to-Channel Skew (Note 4) | | 0 | 0.3 | 3.0 | ns |
| t_{SK2} | Chip to Chip Skew (Note 5) | | | 4.5 | ns | |
| t_{PHZ} | Disable Time High to Z | $R_L = 100\Omega$, $C_L = 5\text{ pF}$ (Figure 4 and Figure 5) | | 2.5 | 20 | ns |
| t_{PLZ} | Disable Time Low to Z | | | 2.5 | 20 | ns |
| t_{PZH} | Enable Time Z to High | | | 2.5 | 20 | ns |
| t_{PZL} | Enable Time Z to Low | | | 2.5 | 20 | ns |

Parameter Measurement Information

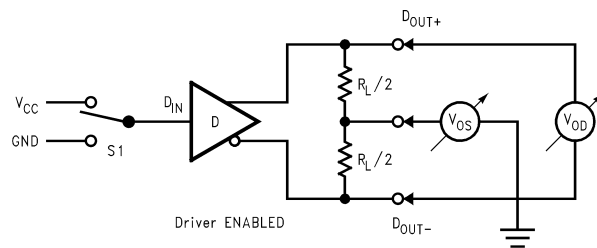


FIGURE 1. Driver V_{OD} and V_{OS} Test Circuit

Parameter Measurement Information (Continued)

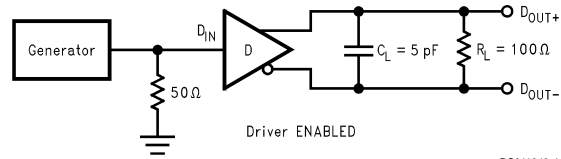


FIGURE 2. Driver Propagation Delay and Transition Time Test Circuit

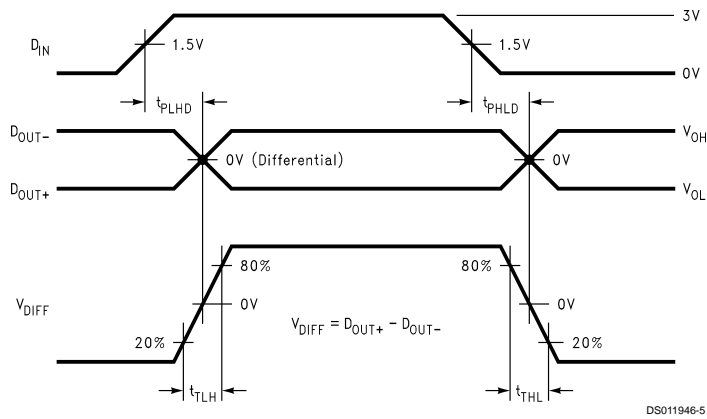


FIGURE 3. Driver Propagation Delay and Transition Time Waveforms

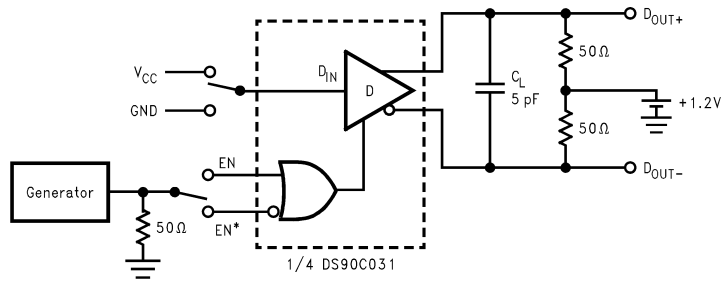


FIGURE 4. Driver TRI-STATE Delay Test Circuit

Parameter Measurement Information (Continued)

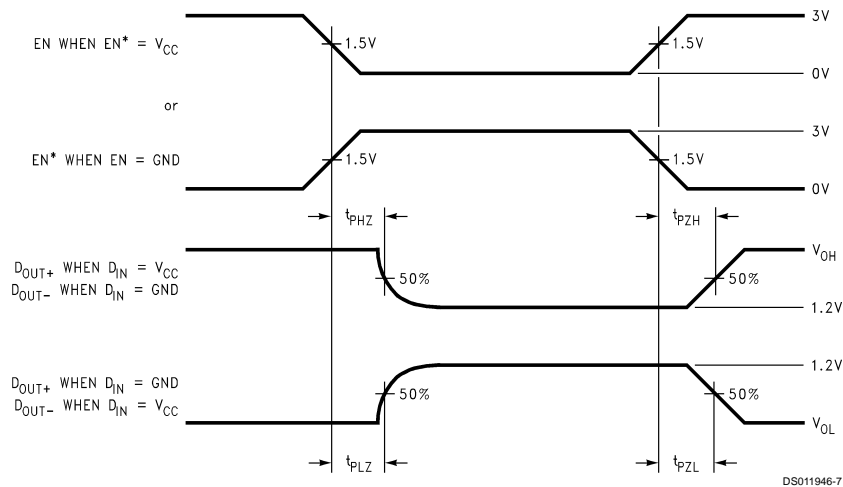


FIGURE 5. Driver TRI-STATE Delay Waveform

Typical Application

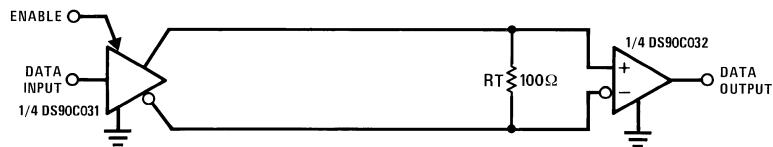


FIGURE 6. Point-to-Point Application

Applications Information

LVDS drivers and receivers are intended to be primarily used in an uncomplicated point-to-point configuration as is shown in Figure 6. This configuration provides a clean signaling environment for the quick edge rates of the drivers. The receiver is connected to the driver through a balanced media which may be a standard twisted pair cable, a parallel pair cable, or simply PCB traces. Typically, the characteristic impedance of the media is in the range of 100Ω. A termination resistor of 100Ω should be selected to match the media, and is located as close to the receiver input pins as possible. The termination resistor converts the current sourced by the driver into a voltage that is detected by the receiver. Other configurations are possible such as a multi-receiver configuration, but the effects of a mid-stream connector(s), cable stub(s), and other impedance discontinuities as well as ground shifting, noise margin limits, and total termination loading must be taken into account.

The DS90C031 differential line driver is a balanced current source design. A current mode driver, generally speaking has a high output impedance and supplies a constant current for a range of loads (a voltage mode driver on the other hand supplies a constant voltage for a range of loads). Current is switched through the load in one direction to produce a logic state and in the other direction to produce the other logic state. The typical output current is mere 3.4 mA, a minimum of 2.5 mA, and a maximum of 4.5 mA. The current mode requires (as discussed above) that a resistive termi-

nation be employed to terminate the signal and to complete the loop as shown in Figure 6. AC or unterminated configurations are not allowed. The 3.4 mA loop current will develop a differential voltage of 340 mV across the 100Ω termination resistor which the receiver detects with a 240 mV minimum differential noise margin neglecting resistive line losses (driven signal minus receiver threshold (340 mV – 100 mV = 240 mV)). The signal is centered around +1.2V (Driver Offset, V_{OS}) with respect to ground as shown in Figure 7. Note that the steady-state voltage (V_{SS}) peak-to-peak swing is twice the differential voltage (V_{OD}) and is typically 680 mV.

The current mode driver provides substantial benefits over voltage mode drivers, such as an RS-422 driver. Its quiescent current remains relatively flat versus switching frequency. Whereas the RS-422 voltage mode driver increases exponentially in most case between 20 MHz–50 MHz. This is due to the overlap current that flows between the rails of the device when the internal gates switch. Whereas the current mode driver switches a fixed current between its output without any substantial overlap current. This is similar to some ECL and PECL devices, but without the heavy static I_{CC} requirements of the ECL/PECL designs. LVDS requires 80% less current than similar PECL devices. AC specifications for the driver are a tenfold improvement over other existing RS-422 drivers.

The TRI-STATE function allows the driver outputs to be disabled, thus obtaining an even lower power state when the transmission of data is not required.

Applications Information (Continued)

The footprint of the DS90C031 is the same as the industry standard 26LS31 Quad Differential (RS-422) Driver.

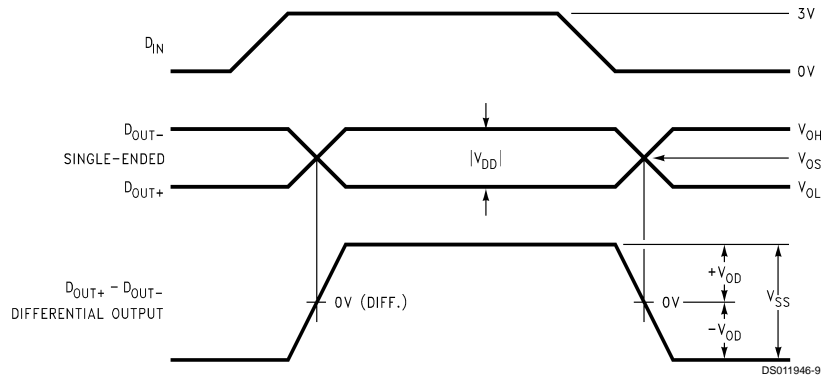


FIGURE 7. Driver Output Levels

Pin Descriptions

| Pin No. (SOIC) | Name | Description |
|----------------|-------------------|--|
| 1, 7, 9, 15 | D _{IN} | Driver input pin, TTL/CMOS compatible |
| 2, 6, 10, 14 | D _{OUT+} | Non-inverting driver output pin, LVDS levels |
| 3, 5, 11, 13 | D _{OUT-} | Inverting driver output pin, LVDS levels |
| 4 | EN | Active high enable pin, OR-ed with EN* |
| 12 | EN* | Active low enable pin, OR-ed with EN |

| Pin No. (SOIC) | Name | Description |
|----------------|-----------------|-----------------------------|
| 16 | V _{CC} | Power supply pin, +5V ± 10% |
| 8 | GND | Ground pin |

Ordering Information

| Operating Temperature | Package Type/ Number | Order Number |
|-----------------------|----------------------|---------------|
| -40°C to +85°C | SOP/M16A | DS90C031TM |
| -55°C to +125°C | LCC/E20A | DS90C031E-QML |
| DS90C031E-QML | (NSID) | |
| 5962-95833 | (SMD) | |

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" specifies conditions of device operation.

Note 2: Current into device pins is defined as positive. Current out of device pins is defined as negative. All voltages are referenced to ground except: V_{OD1} and ΔV_{OD1}.

Note 3: All typicals are given for: V_{CC} = +5.0V, T_A = +25°C.

Note 4: Channel-to-Channel Skew is defined as the difference between the propagation delay of the channel and the other channels in the same chip with an event on the inputs.

Note 5: Chip to Chip Skew is defined as the difference between the minimum and maximum specified differential propagation delays.

Note 6: Generator waveform for all tests unless otherwise specified: f = 1 MHz, Z_O = 50Ω, t_r ≤ 6 ns, and t_f ≤ 6 ns.

Note 7: ESD Ratings:

HBM (1.5 kΩ, 100 pF) ≥ 3,500V

EIAJ (0Ω, 200 pF) ≥ 250V

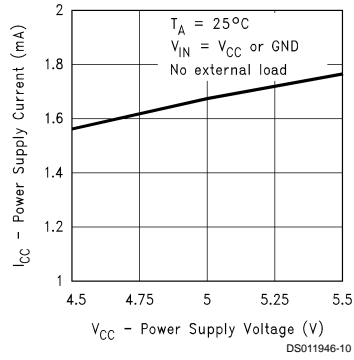
Note 8: Output short circuit current (I_{OS}) is specified as magnitude only, minus sign indicates direction only.

Note 9: C_L includes probe and jig capacitance.

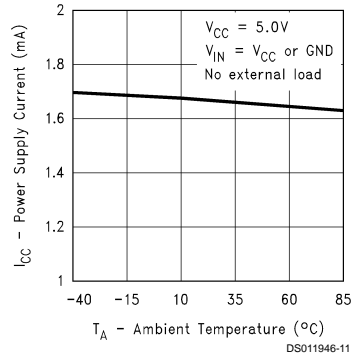
Note 10: Guaranteed by characterization data (DS90C031E).

Typical Performance Characteristics

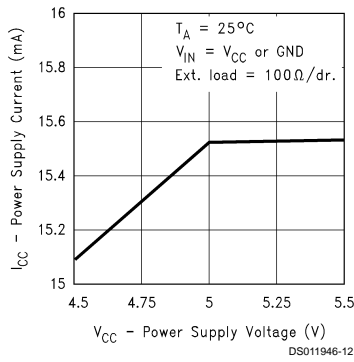
Power Supply Current vs Power Supply Voltage



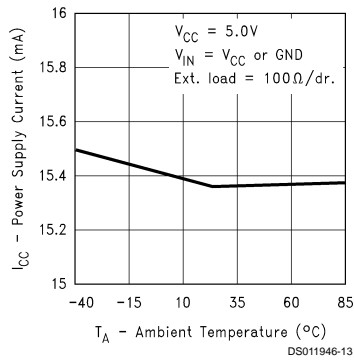
Power Supply Current vs Temperature



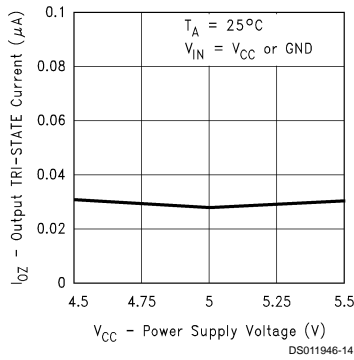
Power Supply Current vs Power Supply Voltage



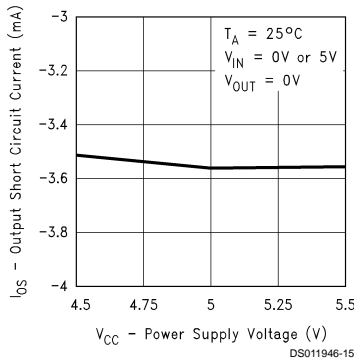
Power Supply Current vs Temperature



Output TRI-STATE Current vs Power Supply Voltage

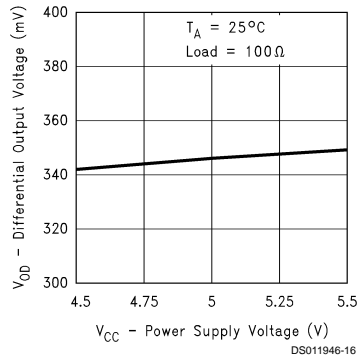


Output Short Circuit Current vs Power Supply Voltage

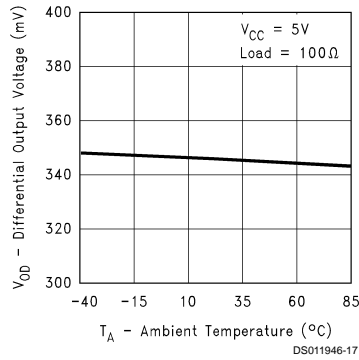


Typical Performance Characteristics (Continued)

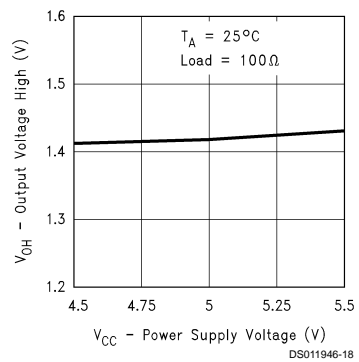
Differential Output Voltage vs Power Supply Voltage



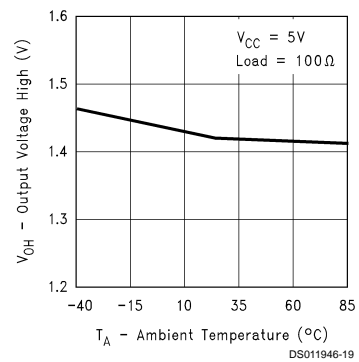
Differential Output Voltage vs Ambient Temperature



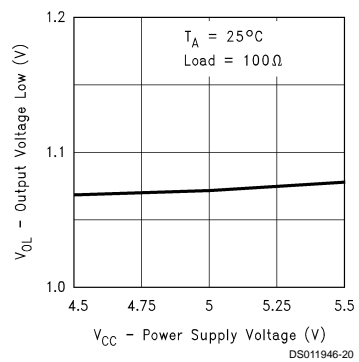
Output Voltage High vs Power Supply Voltage



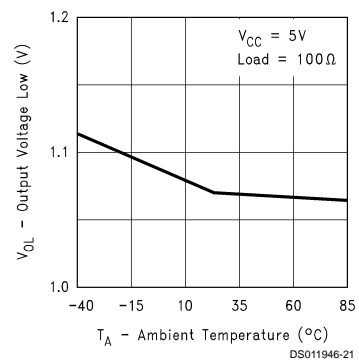
Output Voltage High vs Ambient Temperature



Output Voltage Low vs Power Supply Voltage

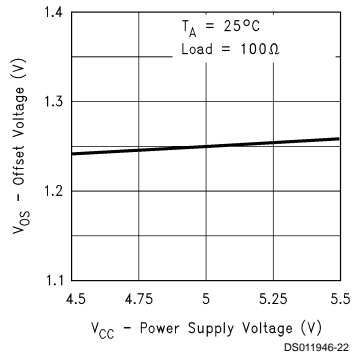


Output Voltage Low vs Ambient Temperature

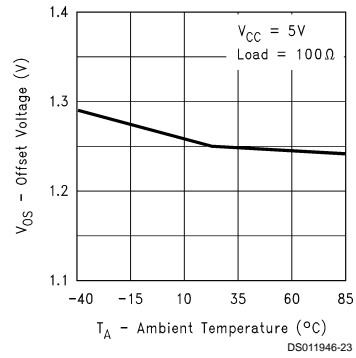


Typical Performance Characteristics (Continued)

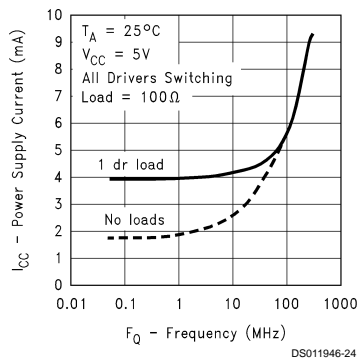
Offset Voltage vs Power Supply Voltage



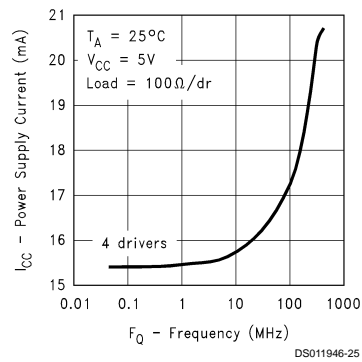
Offset Voltage vs Ambient Temperature



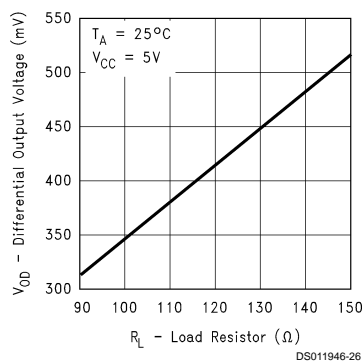
Power Supply Current vs Frequency



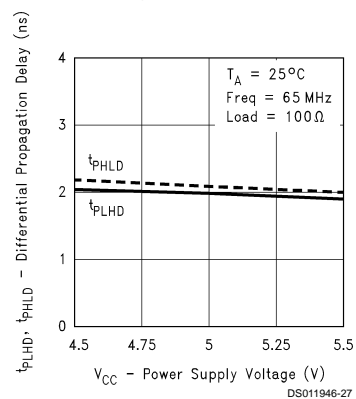
Power Supply Current vs Frequency



Differential Output Voltage vs Load Resistor

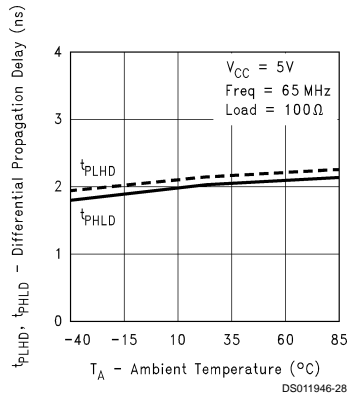


Differential Propagation Delay vs Power Supply Voltage

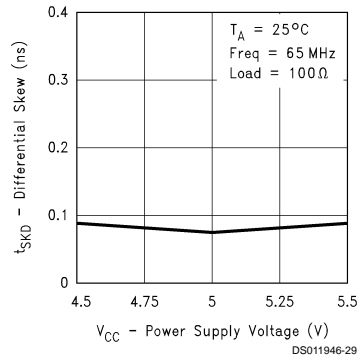


Typical Performance Characteristics (Continued)

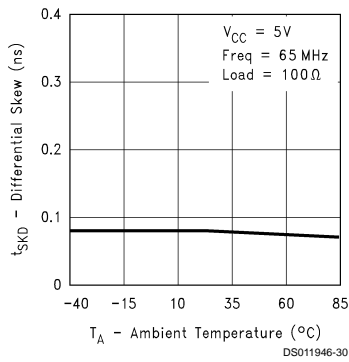
Differential Propagation Delay vs Ambient Temperature



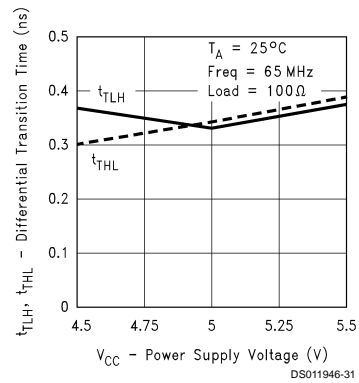
Differential Skew vs Power Supply Voltage



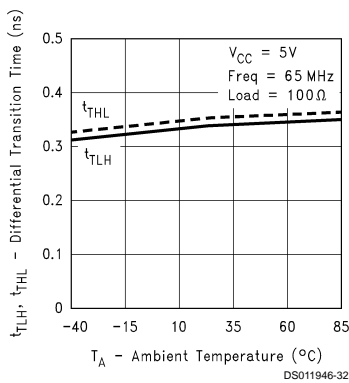
Differential Skew vs Ambient Temperature



Differential Transition Time vs Power Supply Voltage

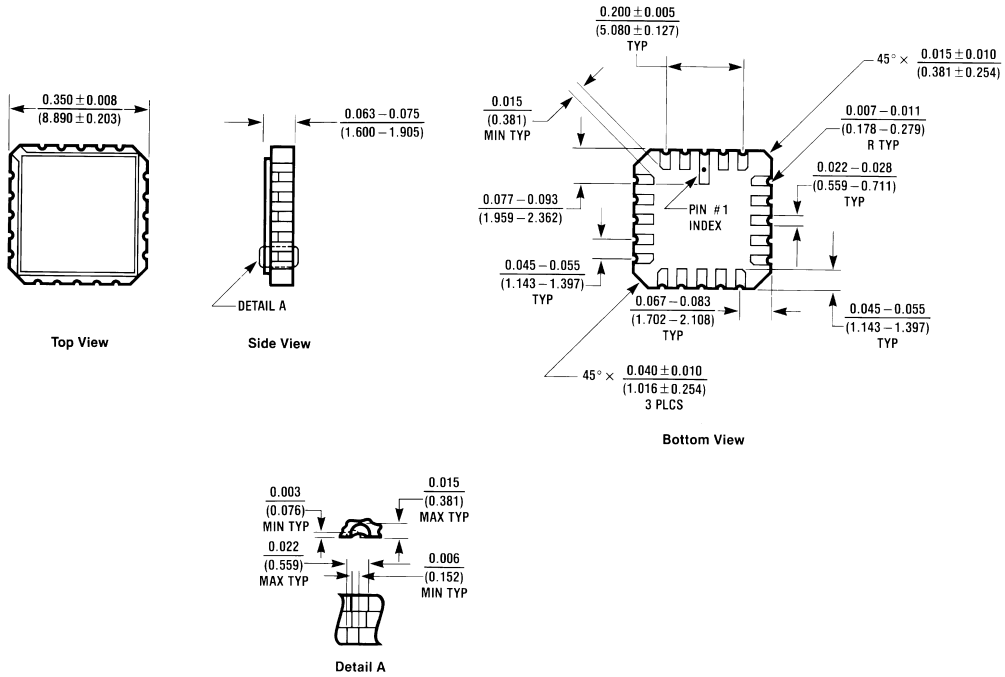


Differential Transition Time vs Ambient Temperature



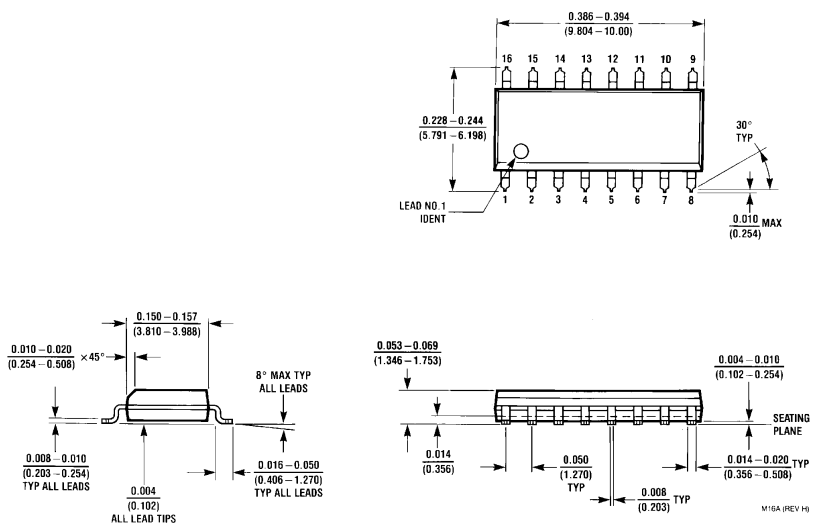


Physical Dimensions inches (millimeters) unless otherwise noted



20-Lead Ceramic Leadless Chip Carrier, Type C
Order Number DS90C031E-QML
NS Package Number E20A

E20A (REV D)



16-Lead (0.150" Wide) Molded Small Outline Package, JEDEC
Order Number DS90C031TM
NS Package Number M16A

M16A (REV H)

LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



National Semiconductor Corporation
Americas
Tel: 1-800-272-9959
Fax: 1-800-737-7018
Email: support@nsc.com

www.national.com

National Semiconductor Europe
Fax: +49 (0) 1 80-530 85 86
Email: europe.support@nsc.com
Deutsch Tel: +49 (0) 1 80-530 85 85
English Tel: +49 (0) 1 80-532 78 32
Français Tel: +49 (0) 1 80-532 93 58
Italiano Tel: +49 (0) 1 80-534 16 80

National Semiconductor Asia Pacific Customer Response Group
Tel: 65-2544466
Fax: 65-2504466
Email: sea.support@nsc.com

National Semiconductor Japan Ltd.
Tel: 81-3-5620-6175
Fax: 81-3-5620-6179